Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	8252	sputter adj deposition	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/31 23:33
L2	397	l1 and porosity	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/31 23:33
L3	364	l1 and porosity and metal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/31 23:34
L4	29	l1 and porosity and metal and melting adj temperature	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/31 23:49
L5	12	(("20020094462") or ("20030190508") or ("20020106540") or ("6569553") or ("6541676") or ("20020081468")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/01 00:11
L6	107863	sputtering and metal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/01 00:12
L7	4295	l6 and porosity	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/01 00:12
L8	374	l7 and melting adj temperature	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/01 00:13